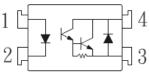


DATASHEET

4 PIN DIP HIGH VOLTAGE PHOTODARLINGTON PHOTOCOUPLER EL852 Series

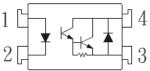




Features:

- Compliance Halogens Free (Only copper leadframe) (Br < 900 ppm, Cl < 900 ppm, Br+Cl < 1500 ppm)
- •High collector- emitter voltage (VCEO=350V)
- Current transfer ratio (CTR: 1000% min. at $I_F = 1mA$, $V_{CE} = 2V$)
- High isolation voltage between input and output (Viso=5000 V rms)
- Creepage distance >7.62 mm
- Operating temperature up to +100°C
- · Compact small outline package
- Pb free and RoHS compliant.
- •UL and cUL approved(No. E214129)
- VDE approved
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CQC approved

Schematic



Pin Configuration

- 1. Anode
- 2. Cathode
- 3. Emitter
- 4. Collector

Description

The EL852 series consists an infrared emitting diodes, optically coupled to a high voltage photo Darlington detector.

It is packaged in a 4-pin DIP package and available in wide-lead spacing and SMD option.

Applications

- Telephone set, telephone exchangers
- Sequence controllers
- System appliances, measuring instruments
- Signal transmission between circuits of different potentials and impedances



Absolute Maximum Ratings (Ta=25℃)

	Parameter	Symbol	Rating	Unit
Input	Forward current	I _F	60	mA
	Peak forward current (1us, pulse)	I _{FP}	1	Α
	Reverse voltage	V_R	6	V
	Power dissipation No derating required up to Ta = 100°C	P _D	100	mW
Output	Power dissipation		300	mW
	Derating factor (above Ta = 80°C)	P _C —	5.8	mW/°C
	Collector current	I _C	150	mA
	Collector-Emitter voltage	V _{CEO}	350	V
	Emitter-Collector voltage	V _{ECO}	0.1	V
Total powe	r dissipation	P _{TOT}	320	mW
Isolation vo	oltage *1	V _{ISO}	5000	V rms
Operating	temperature	T _{OPR}	-55 ~ +100	°C
Storage te	mperature	T _{STG}	-55 ~ +125	°C
Soldering	Temperature*2	T _{SOL}	260	°C
			·	

Notes:

^{*1} AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1 & 2 are shorted together, and pins 3 & 4 are shorted together.

^{*2} For 10 seconds



Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Input

Parameter	Symbol	Min.	Тур.*	Max.	Unit	Condition
Forward Voltage	V_{F}	-	1.2	1.4	V	$I_F = 10 \text{mA}$
Reverse Current	I _R	-	-	10	μA	$V_R = 4V$
Input capacitance	C_{in}	-	30	250	pF	V = 0, $f = 1kHz$

Output

Parameter	Symbol	Min.	Тур.*	Max.	Unit	Condition	
Collector-Emitter dark	I _{CEO}	-	-	200	nA	$V_{CE} = 200V, I_F = 0mA$	
current	'CEO						
Collector-Emitter	BV_CEO	350	_	_	V	$I_{\rm C} = 0.1 \rm mA$	
breakdown voltage	DACEO	000			v	IC = 0.1111A	
Emitter-Collector	BV_{ECO}	0.1	_	_	V	$I_{\rm F} = 0.1 \rm mA$	
breakdown voltage	D A ECO	0.1	-		V	IE = 0. IIIIA	

Transfer Characteristics

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Current Transfer ratio	CTR	1000	-	15000	%	$I_F = 1 \text{mA}$, $V_{CE} = 2 \text{V}$
Collector-Emitter saturation voltage	$V_{CE(sat)}$	-	-	1.2	V	$I_F = 20 \text{mA}$, $I_C = 100 \text{mA}$
Isolation resistance	R _{IO}	5×10 ¹⁰	-	-	Ω	V _{IO} = 500Vdc, 40~60% R.H.
Floating capacitance	C_{IO}	-	0.6	1.0	pF	$V_{IO} = 0$, $f = 1MHz$
Cut-off frequency	fc	-	7	-	kHz	$V_{CE} = 2V$, $I_C = 20mA$ $R_L = 100\Omega$, -3dB
Rise time	t _r	-	-	300	μs	$V_{CE} = 2V, I_{C} = 20mA,$
Fall time	t _f	-	-	100	μs	$R_L = 100\Omega$

^{*} Typical values at T_a = 25°C



Typical Electro-Optical Characteristics Curves

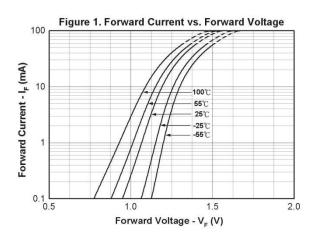


Figure 3. Collector Emitter Saturation Voltage vs.

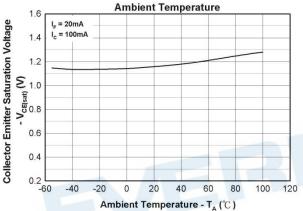
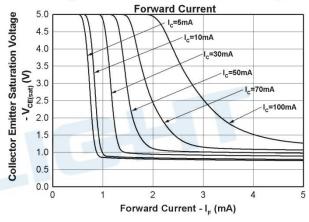


Figure 4. Collector-Emitted Saturation Voltage vs.



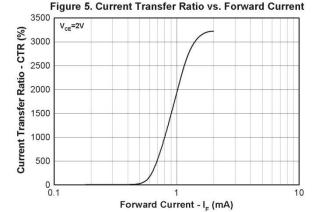


Figure 6. Normalized Current Transfer Ratio vs.

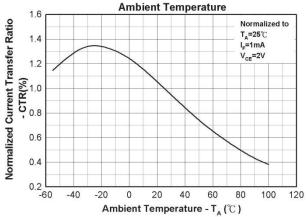
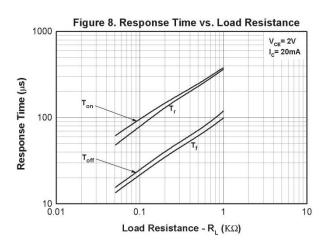
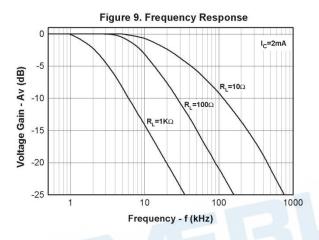




Figure 7. Collector Dark Current vs. **Ambient Temperature** V_{CE}=200V Collector Dark Current - I_{CEO} (nA) 1000 100 10 1 L 90 20 30 50 60 70 80 100 10 Ambient Temperature - TA (℃)







Order Information Part Number

EL852X(Y)-V

Note

X = Lead form option (S, S1, S2, M or none)

= Tape and reel option (TA, TB, TU, TD or none).

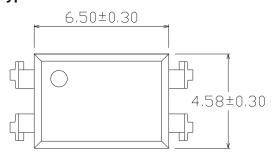
V = VDE safety (optional).

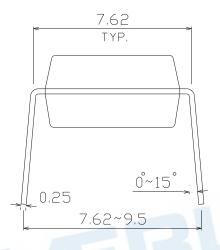
Option	Description	Packing quantity
None	Standard DIP-4	100 units per tube
М	Wide lead bend (0.4 inch spacing)	100 units per tube
S (TA)	Surface mount lead form + TA tape & reel option	1000 units per reel
S (TB)	Surface mount lead form + TB tape & reel option	1000 units per reel
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel
S2 (TA)	Surface mount lead form (Gull-wing) + TA tape & reel option	1000 units per reel
S2 (TB)	Surface mount lead form (Gull-wing) + TB tape & reel option	1000 units per reel
S (TU)	Surface mount lead form + TU tape & reel option	1500 units per reel
S (TD)	Surface mount lead form + TD tape & reel option	1500 units per reel
S1 (TU)	Surface mount lead form (low profile) + TU tape & reel option	1500 units per reel
S1 (TD)	Surface mount lead form (low profile) + TD tape & reel option	1500 units per reel

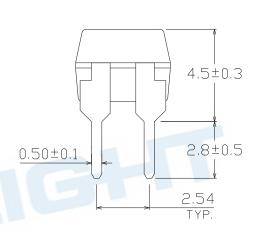


Package Dimension (Dimensions in mm)

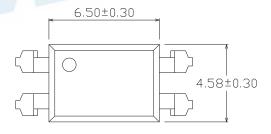
Standard DIP Type

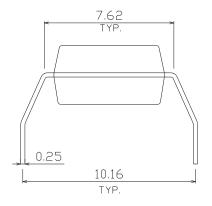


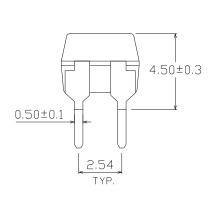




Option M Type

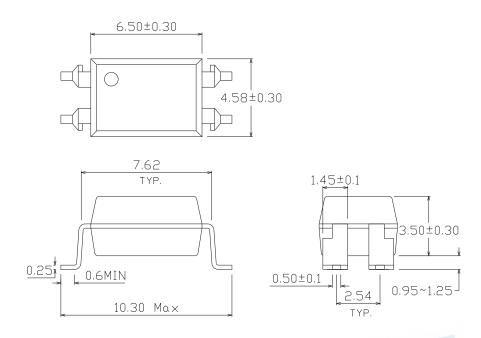




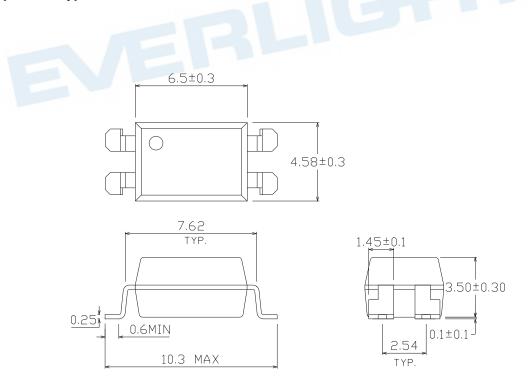




Option S Type

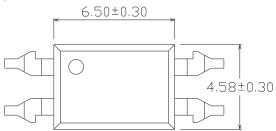


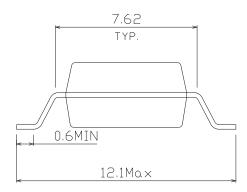
Option S1 Type

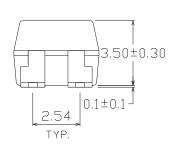




Option S2 Type







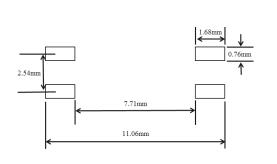


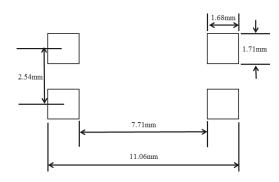


Recommended pad layout for surface mount leadform

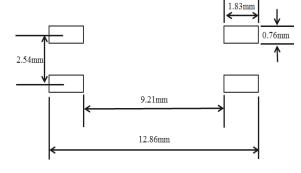
For S option

For S1option





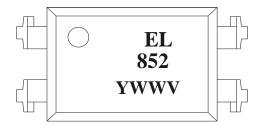
For S2 option



Notes

Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Device Marking



Notes

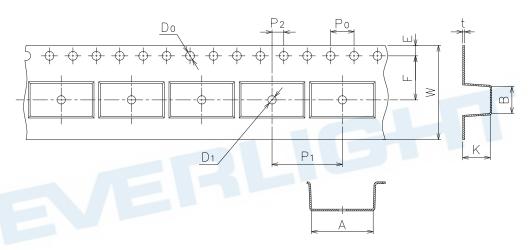
EL denotes EVERLIGHT
852 denotes Device Number
Y denotes 1 digit Year code
WW denotes 2 digit Week code
V denotes VDE optional



Tape & Reel Packing Specifications

Option TA Option TB Direction of feed from reel

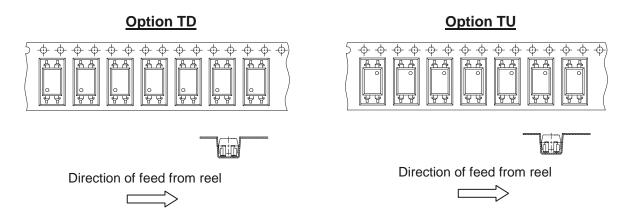
Tape dimensions



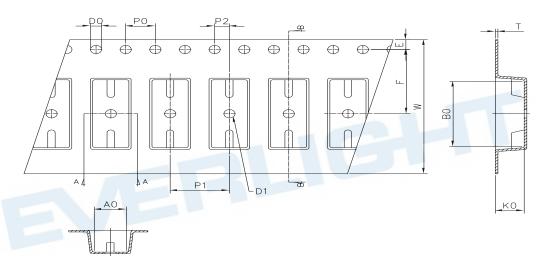
Dimension No.	Α	В	Do	D1	E	F
Dimension (mm) S	10.7±0.1	4.65±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.5±0.1
Dimension (mm) S1	10.7±0.1	4.65±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.5±0.1
Dimension (mm) S2	12.15±0.1	4.65±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.5±0.1
Dimension No.	Ро	P1	P2	t	w	К
Dimension (mm) S	4.0±0.1	12.0±0.1	2.0±0.1	0.4±0.1	16.0±0.3	4.75±0.1
Dimension (mm) S1	4.0±0.1	12.0±0.1	2.0±0.1	0.4±0.1	16.0±0.3	3.90±0.1
Dimension (mm) S2	4.0±0.1	16.0±0.1	2.0±0.1	0.4±0.1	16.0±0.3	3.90±0.1



Tape & Reel Packing Specifications



Tape dimensions



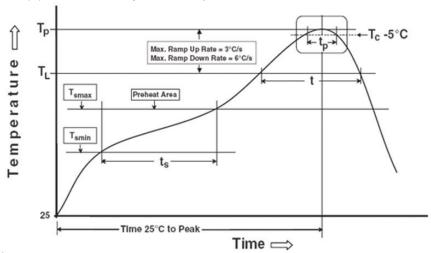
Dimension No.	Ao	Во	Do	D1	E	F
Dimension (mm) S.S1	4.90±0.1	10.40±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.50±0.1
Dimension No.	Ро	P1	P2	t	W	Ko
Dimension (mm) S.S1	4.00±0.1	8.00±0.	2.00±0.1	0.40±0.1	16.00±0.3	4.60±0.1



Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Preheat

Temperature min (T_{smin})

Temperature max (T_{smax})

Time $(T_{smin} \text{ to } T_{smax})$ (t_s)

Average ramp-up rate (T_{smax} to T_p)

Other

Liquidus Temperature (T_L)

Time above Liquidus Temperature (t L)

Peak Temperature (T_P)

Time within 5 °C of Actual Peak Temperature: T_P - 5°C

Ramp- Down Rate from Peak Temperature

Time 25°C to peak temperature

Reflow times

Reference: IPC/JEDEC J-STD-020D

150 °C

200°C

60-120 seconds

3 °C/second max

217 °C

60-100 sec

260°C

30 s

6°C /second max.

8 minutes max.

3 times



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